

FEATURES

- 50Ω Matched 20MHz to 1400MHz
- 20.8dB Power Gain
- 46.2dBm OIP3 at 240MHz Into 50Ω
- NF = 2.6dB at 240MHz
- 0.6nV/√Hz Total Input Noise
- S11 < -10dB Up to 2.0GHz
- S22 < -10dB Up to 1.4GHz
- >2.0V_{P-P} Linear Output Swing
- P1dB = 22.0dBm
- 50Ω Single-Ended Input/Output
- Insensitive to V_{CC} Variation
- A-Grade 100% OIP3 Tested at 240MHz
- Input/Output Internally Matched to 50Ω
- Single 5V Supply

APPLICATIONS

- Single-Ended IF Amplifier
- ADC Driver
- CATV

DESCRIPTION

The **LTC®6431-20** is a gain block amplifier exhibiting excellent linearity at frequencies beyond 1000MHz and with low associated output noise.

The unique combination of linearity, low noise and low power dissipation make this an ideal candidate for many signal-chain applications. The LTC6431-20 is easy to use, requiring a minimum of external components. It is internally input/output matched to 50Ω and it draws only 93mA from a single 5V supply.

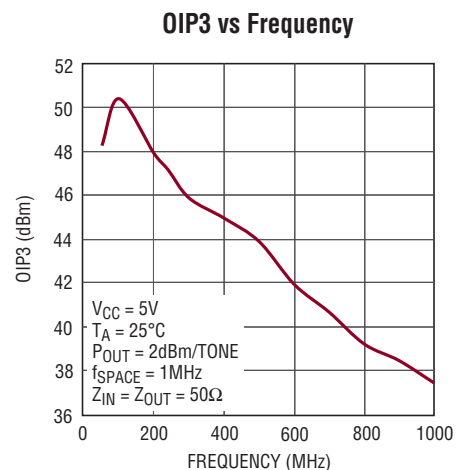
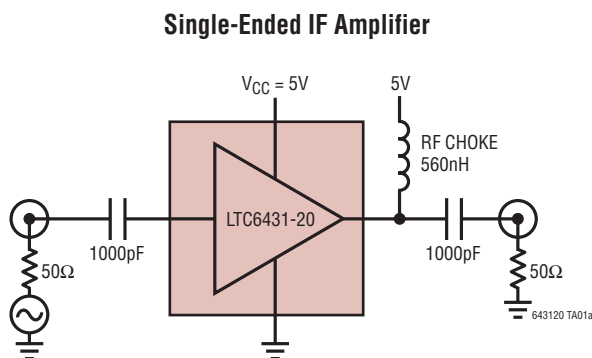
On-chip bias and temperature compensation maintain performance over environmental changes.

The LTC6431-20 uses a high performance SiGe BiCMOS process for excellent repeatability compared with similar GaAs amplifiers. All A-grade LTC6431-20 devices are tested and guaranteed for OIP3 at 240MHz. The LTC6431-20 is housed in a 4mm × 4mm 24-lead QFN package with an exposed pad for thermal management and low inductance.

LTC6431 FAMILY	GAIN
LTC6431-15	15.5dB
LTC6431-20	20.8dB

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TYPICAL APPLICATION



643120 TA01b

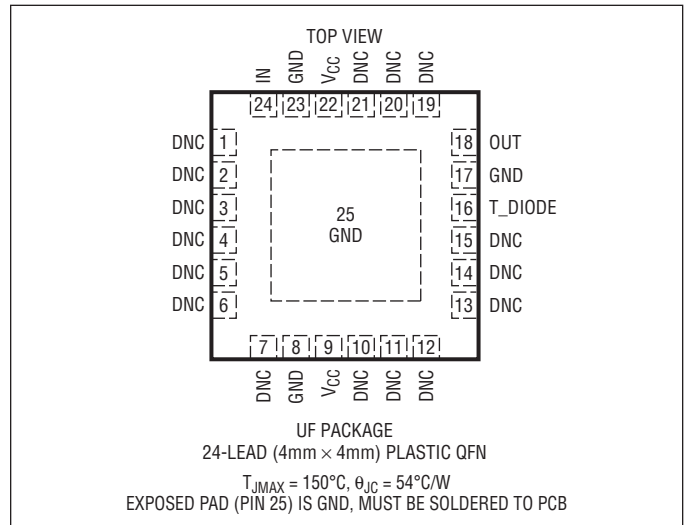
LTC6431-20

ABSOLUTE MAXIMUM RATINGS

(Note 1)

Total Supply Voltage (V_{CC} to GND).....	5.5V
Amplifier Output Current (+OUT)	120mA
RF Input Power, Continuous, 50 Ω (Note 2).....	15dBm
RF Input Power, 100 μ s Pulse, 50 Ω (Note 2)	20dBm
Operating Case Temperature Range (T_{CASE}).....	-40°C to 85°C
Storage Temperature Range	-65°C to 150°C
Junction Temperature (T_J)	150°C

PIN CONFIGURATION



ORDER INFORMATION

LEAD FREE FINISH	TAPE AND REEL	PART MARKING*	PACKAGE DESCRIPTION	TEMPERATURE RANGE
LTC6431AIUF-20#PBF	LTC6431AIUF-20#TRPBF	43120	24-Lead (4mm x 4mm) Plastic QFN	-40°C to 85°C T_{CASE}
LTC6431BIUF-20#PBF	LTC6431BIUF-20#TRPBF	43120	24-Lead (4mm x 4mm) Plastic QFN	-40°C to 85°C T_{CASE}

Consult LTC Marketing for parts specified with wider operating temperature ranges. *The temperature grade is identified by a label on the shipping container. Consult LTC Marketing for information on nonstandard lead based finish parts.

For more information on lead free part marking, go to: <http://www.linear.com/leadfree/>

For more information on tape and reel specifications, go to: <http://www.linear.com/tapeandree/>

DC ELECTRICAL CHARACTERISTICS The ● denotes the specifications which apply over the full operating temperature range, otherwise specifications are at $T_A = 25^\circ\text{C}$. $V_{CC} = 5\text{V}$, $Z_{SOURCE} = Z_{LOAD} = 50\Omega$. Typical measured DC electrical performance using Test Circuit A.

SYMBOL	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
V_S	Operating Supply Range		● 4.75	5.0	5.25	V
$I_{S(TOT)}$	Total Supply Current	All V_{CC} Pins Plus OUT	● 75	93	113	mA
			● 68		129	mA
$I_{S(OUT)}$	Total Supply Current to OUT Pin	Current to OUT	● 55	75	95	mA
			● 51		115	mA
I_{CC}	Current to V_{CC} Pin	Either V_{CC} Pin May Be Used	● 15	18	21	mA
			● 12.5		21.5	mA

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AC ELECTRICAL CHARACTERISTICS The ● denotes the specifications which apply over the full operating temperature range, otherwise specifications are at $T_A = 25^\circ\text{C}$ (Note 3). $V_{CC} = 5\text{V}$, $Z_{SOURCE} = Z_{LOAD} = 50\Omega$ unless otherwise noted. Measurements are performed using Test Circuit A, measuring from 50Ω SMA to 50Ω without de-embedding (Note 4).

SYMBOL	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
Small Signal						
BW	-3dB Bandwidth	De-embedded to Package (Low Frequency Cutoff = 20MHz)		2000		MHz
S11	Input Return Loss 20MHz to 2000MHz	De-embedded to Package		-10		dB
S21	Forward Power Gain 50MHz to 1000MHz	De-embedded to Package		20.8		dB
S12	Reverse Isolation 20MHz to 3000MHz	De-embedded to Package		-23		dB
S22	Output Return Loss 20MHz to 1400MHz	De-embedded to Package		-10		dB
Frequency = 50MHz						
S21	Power Gain	De-embedded to Package		21.1		dB
OIP3	Output Third-Order Intercept Point	$P_{OUT} = 2\text{dBm/Tone}$, $\Delta f = 1\text{MHz}$, A-Grade $P_{OUT} = 2\text{dBm/Tone}$, $\Delta f = 1\text{MHz}$, B-Grade		48.2 47.2		dBm dBm
IM3	Third-Order Intermodulation	$P_{OUT} = 2\text{dBm/Tone}$, $\Delta f = 1\text{MHz}$, A-Grade $P_{OUT} = 2\text{dBm/Tone}$, $\Delta f = 1\text{MHz}$, B-Grade		-92.4 -90.4		dBc dBc
HD2	Second Harmonic Distortion	$P_{OUT} = 6\text{dBm}$		-53.5		dBc
HD3	Third Harmonic Distortion	$P_{OUT} = 6\text{dBm}$		-93.6		dBc
P1dB	Output 1dB Compression Point			23.5		dBm
NF	Noise Figure	De-embedded to Package		2.6		dB
Frequency = 140MHz						
S21	Power Gain	De-embedded to Package		21.0		dB
OIP3	Output Third-Order Intercept Point	$P_{OUT} = 2\text{dBm/Tone}$, $\Delta f = 1\text{MHz}$, A-Grade $P_{OUT} = 2\text{dBm/Tone}$, $\Delta f = 1\text{MHz}$, B-Grade		48.8 47.8		dBm dBm
IM3	Third-Order Intermodulation	$P_{OUT} = 2\text{dBm/Tone}$, $\Delta f = 1\text{MHz}$, A-Grade $P_{OUT} = 2\text{dBm/Tone}$, $\Delta f = 1\text{MHz}$, B-Grade		-93.6 -91.6		dBc dBc
HD2	Second Harmonic Distortion	$P_{OUT} = 6\text{dBm}$		-55.8		dBc
HD3	Third Harmonic Distortion	$P_{OUT} = 6\text{dBm}$		-96.6		dBc
P1dB	Output 1dB Compression Point			23.0		dBm
NF	Noise Figure	De-embedded to Package		2.7		dB
Frequency = 240MHz						
S21	Power Gain	De-embedded to Package	●	19.4 19.0	21.0 21.4 21.5	dB dB
OIP3	Output Third-Order Intercept Point	$P_{OUT} = 2\text{dBm/Tone}$, $\Delta f = 1\text{MHz}$, A-Grade $P_{OUT} = 2\text{dBm/Tone}$, $\Delta f = 1\text{MHz}$, B-Grade		42.2 46.2 45.7		dBm dBm
IM3	Third-Order Intermodulation	$P_{OUT} = 2\text{dBm/Tone}$, $\Delta f = 1\text{MHz}$, A-Grade $P_{OUT} = 2\text{dBm/Tone}$, $\Delta f = 1\text{MHz}$, B-Grade		-90.4 -87.4	-80.4	dBc dBc
HD2	Second Harmonic Distortion	$P_{OUT} = 6\text{dBm}$		-50.5		dBc
HD3	Third Harmonic Distortion	$P_{OUT} = 6\text{dBm}$		-92.5		dBc
P1dB	Output 1dB Compression Point			22.0		dBm
NF	Noise Figure	De-embedded to Package		2.6		dB

AC ELECTRICAL CHARACTERISTICS The ● denotes the specifications which apply over the full operating temperature range, otherwise specifications are at $T_A = 25^\circ\text{C}$ (Note 3). $V_{CC} = 5\text{V}$, $Z_{SOURCE} = Z_{LOAD} = 50\Omega$ unless otherwise noted. Measurements are performed using Test Circuit A, measuring from 50Ω SMA to 50Ω without de-embedding (Note 4).

SYMBOL	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
Frequency = 300 MHz						
S21	Power Gain	De-embedded to Package		20.9		dB
OIP3	Output Third-Order Intercept Point	$P_{OUT} = 2\text{dBm/Tone}$, $\Delta f = 1\text{MHz}$, A-Grade $P_{OUT} = 2\text{dBm/Tone}$, $\Delta f = 1\text{MHz}$, B-Grade		45.9 44.8		dBm dBm
IM3	Third-Order Intermodulation	$P_{OUT} = 2\text{dBm/Tone}$, $\Delta f = 1\text{MHz}$, A-Grade $P_{OUT} = 2\text{dBm/Tone}$, $\Delta f = 1\text{MHz}$, B-Grade		-87.8 -85.6		dBc dBc
HD2	Second Harmonic Distortion	$P_{OUT} = 6\text{dBm}$		-50.5		dBc
HD3	Third Harmonic Distortion	$P_{OUT} = 6\text{dBm}$		-83.0		dBc
P1dB	Output 1dB Compression Point			21.8		dBm
NF	Noise Figure	De-embedded to Package		2.7		dB
Frequency = 380MHz						
S21	Power Gain	De-embedded to Package		20.9		dB
OIP3	Output Third-Order Intercept Point	$P_{OUT} = 2\text{dBm/Tone}$, $\Delta f = 1\text{MHz}$, A-Grade $P_{OUT} = 2\text{dBm/Tone}$, $\Delta f = 1\text{MHz}$, B-Grade		45.0 44.0		dBm dBm
IM3	Third-Order Intermodulation	$P_{OUT} = 2\text{dBm/Tone}$, $\Delta f = 1\text{MHz}$, A-Grade $P_{OUT} = 2\text{dBm/Tone}$, $\Delta f = 1\text{MHz}$, B-Grade		-86.0 -84.0		dBc dBc
HD2	Second Harmonic Distortion	$P_{OUT} = 6\text{dBm}$		-50.4		dBc
HD3	Third Harmonic Distortion	$P_{OUT} = 6\text{dBm}$		-77.4		dBc
P1dB	Output 1dB Compression Point			21.7		dBc
NF	Noise Figure	De-embedded to Package		2.8		dB
Frequency = 500MHz						
S21	Power Gain	De-embedded to Package		20.8		dB
OIP3	Output Third-Order Intercept Point	$P_{OUT} = 2\text{dBm/Tone}$, $\Delta f = 1\text{MHz}$, A-Grade $P_{OUT} = 2\text{dBm/Tone}$, $\Delta f = 1\text{MHz}$, B-Grade		43.9 42.9		dBm dBm
IM3	Third-Order Intermodulation	$P_{OUT} = 2\text{dBm/Tone}$, $\Delta f = 1\text{MHz}$, A-Grade $P_{OUT} = 2\text{dBm/Tone}$, $\Delta f = 1\text{MHz}$, B-Grade		-83.8 -81.8		dBc dBc
HD2	Second Harmonic Distortion	$P_{OUT} = 6\text{dBm}$		-47.8		dBc
HD3	Third Harmonic Distortion	$P_{OUT} = 6\text{dBm}$		-72.6		dBc
P1dB	Output 1dB Compression Point			21.8		dBm
NF	Noise Figure	De-embedded to Package		2.9		dB
Frequency = 600MHz						
S21	Power Gain	De-embedded to Package		20.8		dB
OIP3	Output Third-Order Intercept Point	$P_{OUT} = 2\text{dBm/Tone}$, $\Delta f = 1\text{MHz}$, A-Grade $P_{OUT} = 2\text{dBm/Tone}$, $\Delta f = 1\text{MHz}$, B-Grade		41.9 40.9		dBm dBm
IM3	Third-Order Intermodulation	$P_{OUT} = 2\text{dBm/Tone}$, $\Delta f = 1\text{MHz}$, A-Grade $P_{OUT} = 2\text{dBm/Tone}$, $\Delta f = 1\text{MHz}$, B-Grade		-79.8 -77.8		dBc dBc
HD2	Second Harmonic Distortion	$P_{OUT} = 6\text{dBm}$		-43.7		dBc
HD3	Third Harmonic Distortion	$P_{OUT} = 6\text{dBm}$		-64.0		dBc
P1dB	Output 1dB Compression Point			21.6		dBm
NF	Noise Figure	De-embedded to Package		3.0		dB

AC ELECTRICAL CHARACTERISTICS The ● denotes the specifications which apply over the full operating temperature range, otherwise specifications are at $T_A = 25^\circ\text{C}$ (Note 3). $V_{CC} = 5\text{V}$, $Z_{SOURCE} = Z_{LOAD} = 50\Omega$ unless otherwise noted. Measurements are performed using Test Circuit A, measuring from 50Ω SMA to 50Ω without de-embedding (Note 4).

SYMBOL	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
Frequency = 700 MHz						
S21	Power Gain	De-embedded to Package		20.8		dB
OIP3	Output Third-Order Intercept Point	$P_{OUT} = 2\text{dBm/Tone}$, $\Delta f = 1\text{MHz}$, A-Grade $P_{OUT} = 2\text{dBm/Tone}$, $\Delta f = 1\text{MHz}$, B-Grade		40.7 39.7		dBm dBm
IM3	Third-Order Intermodulation	$P_{OUT} = 2\text{dBm/Tone}$, $\Delta f = 1\text{MHz}$, A-Grade $P_{OUT} = 2\text{dBm/Tone}$, $\Delta f = 1\text{MHz}$, B-Grade		-77.4 -75.4		dBc dBc
HD2	Second Harmonic Distortion	$P_{OUT} = 6\text{dBm}$		-42.1		dBc
HD3	Third Harmonic Distortion	$P_{OUT} = 6\text{dBm}$		-60.7		dBc
P1dB	Output 1dB Compression Point			21.4		dBm
NF	Noise Figure	De-embedded to Package		3.2		dB
Frequency = 800MHz						
S21	Power Gain	De-embedded to Package		20.8		dB
OIP3	Output Third-Order Intercept Point	$P_{OUT} = 2\text{dBm/Tone}$, $\Delta f = 1\text{MHz}$, A-Grade $P_{OUT} = 2\text{dBm/Tone}$, $\Delta f = 1\text{MHz}$, B-Grade		39.2 38.2		dBm dBm
IM3	Third-Order Intermodulation	$P_{OUT} = 2\text{dBm/Tone}$, $\Delta f = 1\text{MHz}$, A-Grade $P_{OUT} = 2\text{dBm/Tone}$, $\Delta f = 1\text{MHz}$, B-Grade		-74.4 -72.4		dBc dBc
HD2	Second Harmonic Distortion	$P_{OUT} = 6\text{dBm}$		-40.5		dBc
HD3	Third Harmonic Distortion	$P_{OUT} = 6\text{dBm}$		-63.1		dBc
P1dB	Output 1dB Compression Point			21.3		dBm
NF	Noise Figure	De-embedded to Package		3.4		dB
Frequency = 900MHz						
S21	Power Gain	De-embedded to Package		20.8		dB
OIP3	Output Third-Order Intercept Point	$P_{OUT} = 2\text{dBm/Tone}$, $\Delta f = 1\text{MHz}$, A-Grade $P_{OUT} = 2\text{dBm/Tone}$, $\Delta f = 1\text{MHz}$, B-Grade		38.5 37.5		dBm dBm
IM3	Third-Order Intermodulation	$P_{OUT} = 2\text{dBm/Tone}$, $\Delta f = 1\text{MHz}$, A-Grade $P_{OUT} = 2\text{dBm/Tone}$, $\Delta f = 1\text{MHz}$, B-Grade		-73.0 -71.0		dBc dBc
HD2	Second Harmonic Distortion	$P_{OUT} = 6\text{dBm}$		-37.1		dBc
HD3	Third Harmonic Distortion	$P_{OUT} = 6\text{dBm}$		-60.4		dBc
P1dB	Output 1dB Compression Point			21.1		dBm
NF	Noise Figure	De-embedded to Package		3.7		dB
Frequency = 1000MHz						
S21	Power Gain	De-embedded to Package		20.8		dB
OIP3	Output Third-Order Intercept Point	$P_{OUT} = 2\text{dBm/Tone}$, $\Delta f = 1\text{MHz}$, A-Grade $P_{OUT} = 2\text{dBm/Tone}$, $\Delta f = 1\text{MHz}$, B-Grade		37.5 36.5		dBm dBm
IM3	Third-Order Intermodulation	$P_{OUT} = 2\text{dBm/Tone}$, $\Delta f = 1\text{MHz}$, A-Grade $P_{OUT} = 2\text{dBm/Tone}$, $\Delta f = 1\text{MHz}$, B-Grade		-71.0 -69.0		dBc dBc
HD2	Second Harmonic Distortion	$P_{OUT} = 6\text{dBm}$		-36.9		dBc
HD3	Third Harmonic Distortion	$P_{OUT} = 6\text{dBm}$		-55.1		dBc
P1dB	Output 1dB Compression Point			20.8		dBc
NF	Noise Figure	De-embedded to Package		3.8		dB

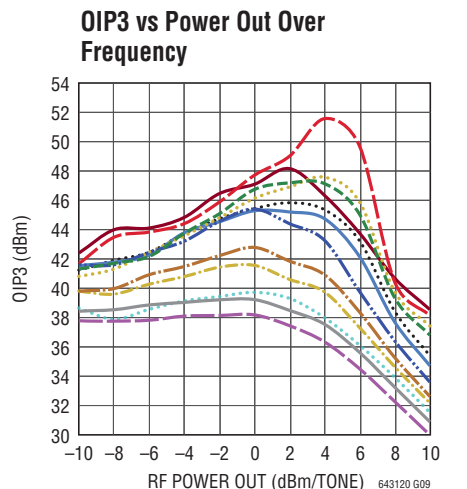
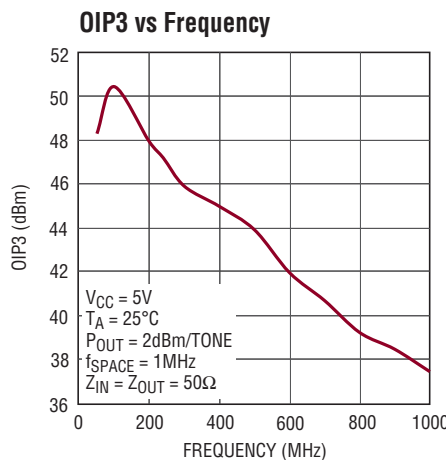
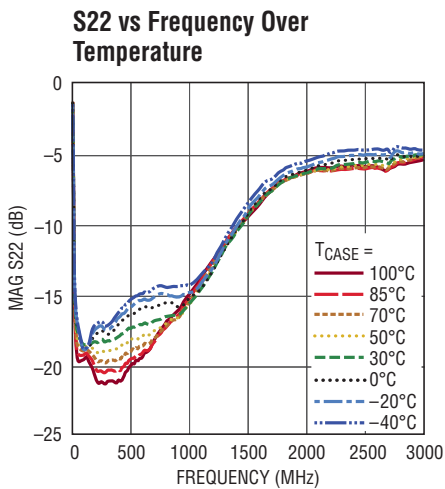
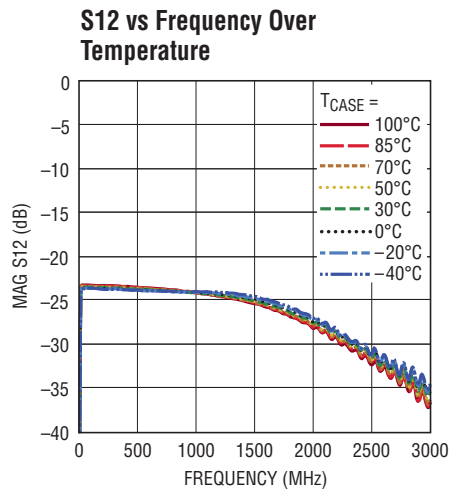
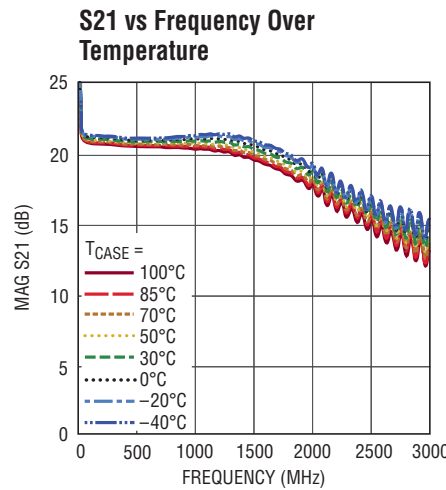
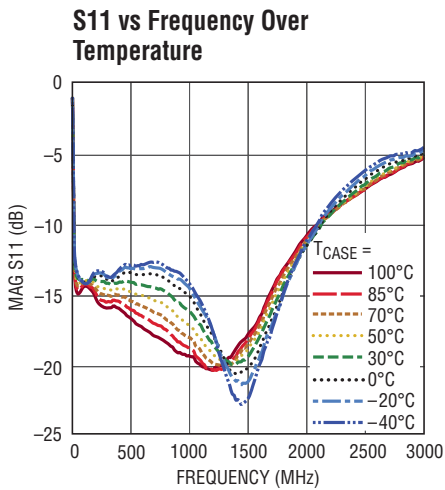
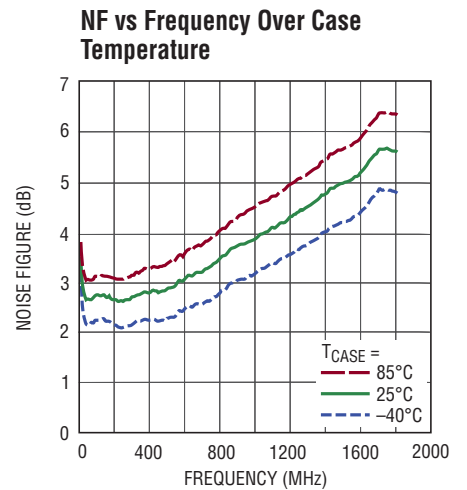
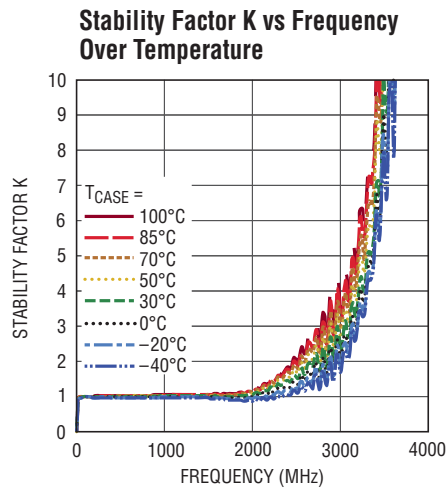
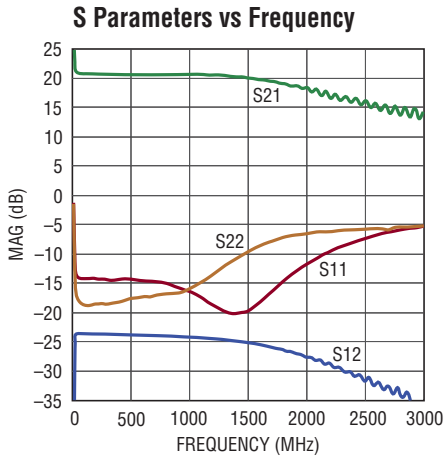
Note 1: Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. Exposure to any Absolute Maximum Rating condition for extended periods may affect device reliability and lifetime.

Note 2: Guaranteed by design and characterization. This parameter is not tested.

Note 3: The LTC6431-20 is guaranteed functional over the case operating temperature range of -40°C to 85°C .

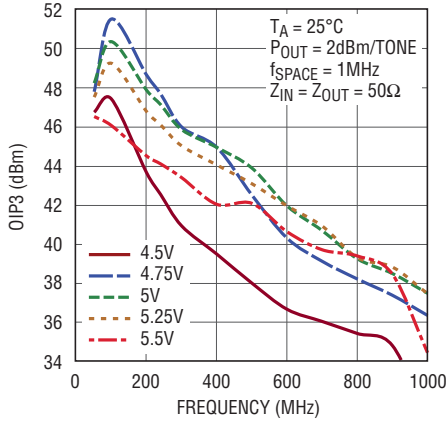
Note 4: Small-signal parameters S and noise are de-embedded to the package pins, while large-signal parameters are measured directly from the circuit.

TYPICAL PERFORMANCE CHARACTERISTICS $T_A = 25^\circ\text{C}$, $V_{CC} = 5\text{V}$, $Z_{SOURCE} = Z_{LOAD} = 50\Omega$ unless otherwise noted. Measurements are performed using Test Circuit A, measuring from 50Ω SMA to 50Ω without de-embedding (Note 4).

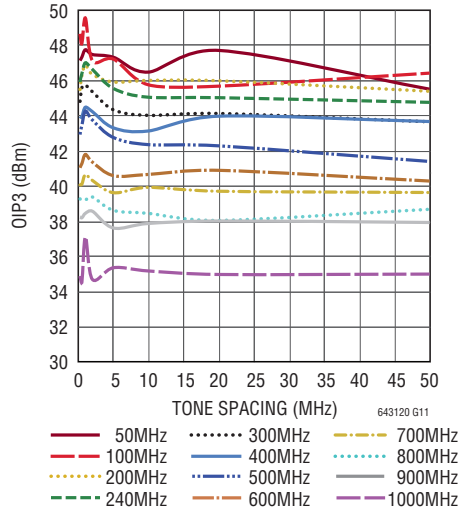


TYPICAL PERFORMANCE CHARACTERISTICS $T_A = 25^\circ\text{C}$, $V_{CC} = 5\text{V}$, $Z_{SOURCE} = Z_{LOAD} = 50\Omega$ unless otherwise noted. Measurements are performed using Test Circuit A, measuring from 50Ω SMA to 50Ω without de-embedding (Note 4).

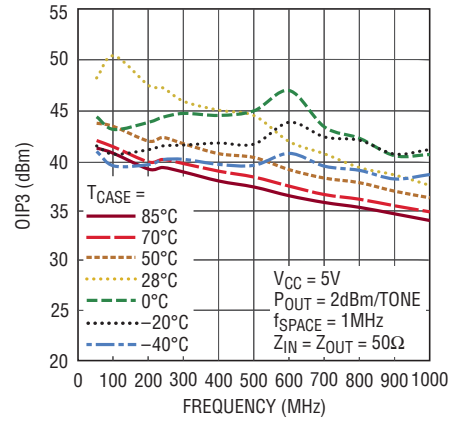
OIP3 vs Frequency Over V_{CC} Voltage



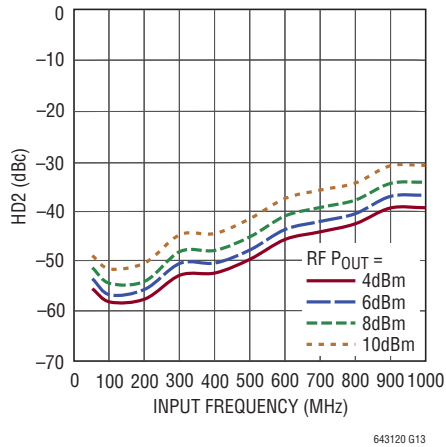
OIP3 vs Tone Spacing Over Frequency



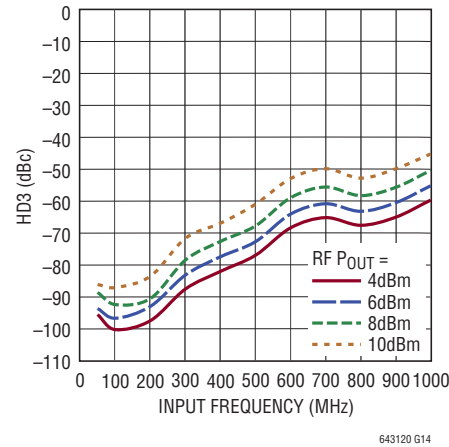
OIP3 vs Frequency Over Case Temperature



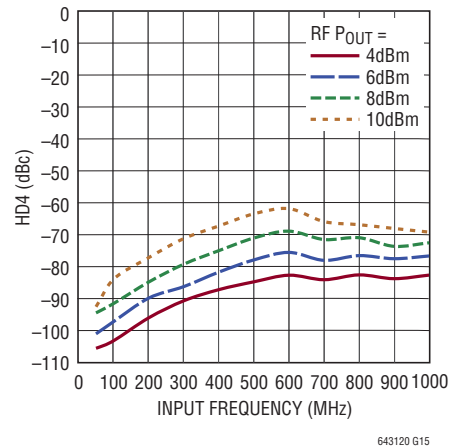
HD2 vs Frequency Over P_{OUT}



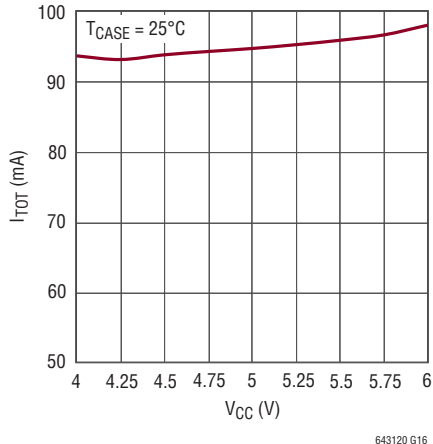
HD3 vs Input Frequency Over P_{OUT}



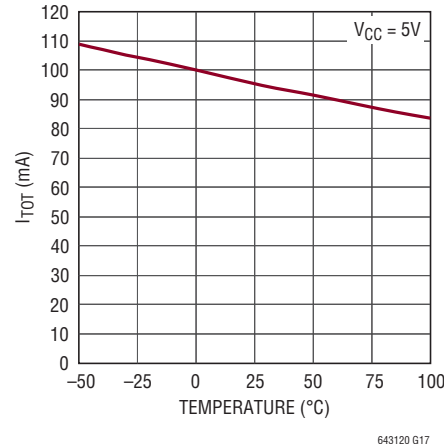
HD4 vs Input Frequency Over P_{OUT}



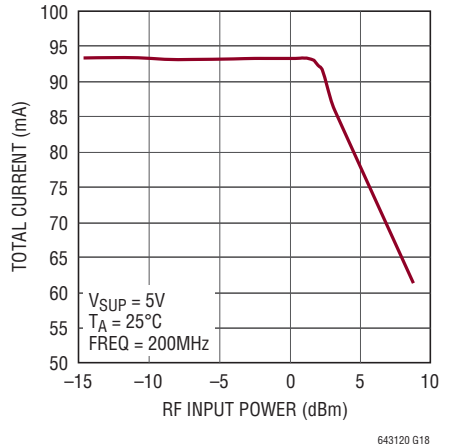
Total Current (I_{TOT}) vs V_{CC}



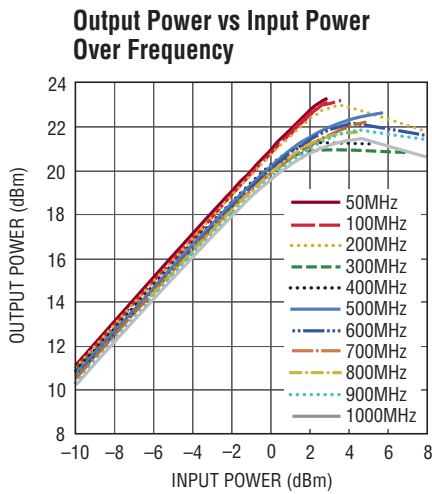
Total Current (I_{TOT}) vs Temperature



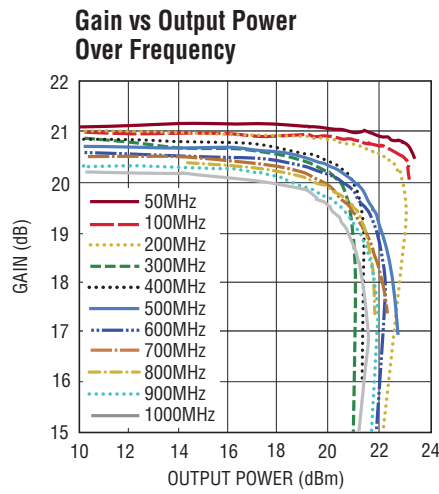
Total Current vs RF Input Power



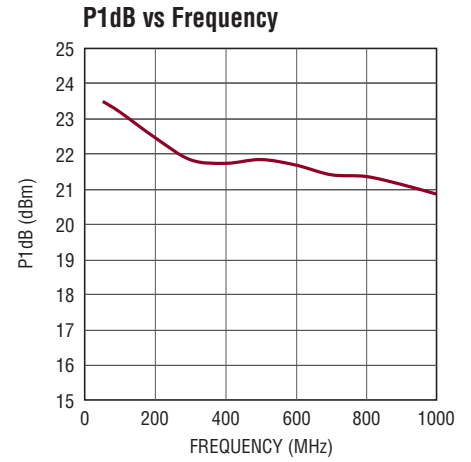
TYPICAL PERFORMANCE CHARACTERISTICS $T_A = 25^\circ\text{C}$, $V_{CC} = 5\text{V}$, $Z_{SOURCE} = Z_{LOAD} = 50\Omega$ unless otherwise noted. Measurements are performed using Test Circuit A, measuring from 50Ω SMA to 50Ω without de-embedding (Note 4).



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643120 G20



643120 G21

PIN FUNCTIONS

DNC (Pins 1 to 7, 10 to 15, 19 to 21): Do Not Connect. Do not connect these pins, allow them to float. **Failure to float these pins may impair operation of the LTC6431-20.**

GND (Pins 8, 17, 23, Exposed Pad Pin 25): Ground. For best RF performance, all ground pins should be connected to the printed circuit board ground plane. The exposed pad (Pin 25) should have multiple via holes to an underlying ground plane for low inductance and good thermal dissipation.

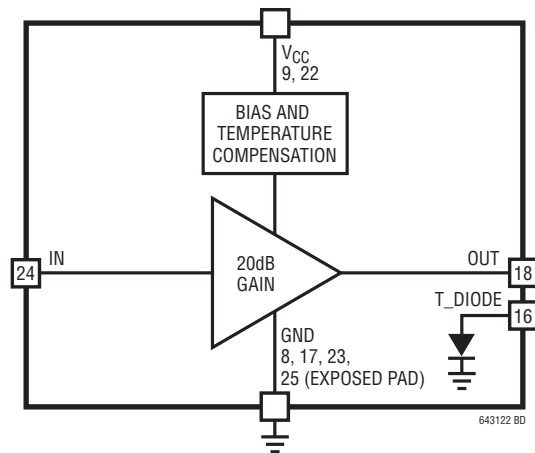
V_{CC} (Pins 9, 22): Positive Power Supply. Either or both V_{CC} pins should be connected to the 5.0V supply. Bypass the V_{CC} pin with 1000pF and 0.1 μF capacitors. The 1000pF capacitor should be physically close to Pin 22.

T_DIODE (Pin 16): Optional Diode. The T_DIODE can be forward biased to ground with 1mA of current. The measured voltage will be an indicator of chip temperature.

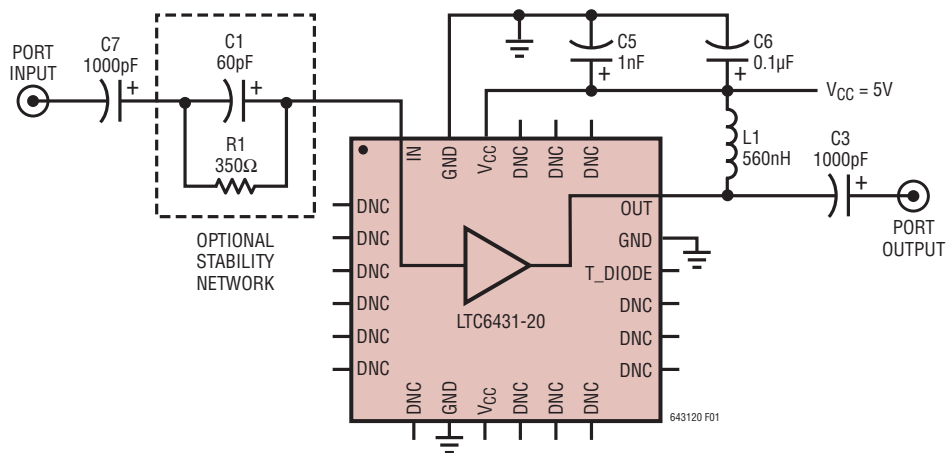
Out (Pin 18): Amplifier Output Pin. A choke inductor is necessary to provide power from the 5V supply and to provide RF isolation. For best performance select a choke with low loss and high self-resonant frequency (SRF). A DC blocking capacitor is also required. See Applications Information Section for specific recommendations.

IN (Pin 24): Signal input pin with internally generated 2.0V DC bias. A DC blocking capacitor is required. See Applications Information Section for specific recommendations.

BLOCK DIAGRAM



TEST CIRCUIT A



OPERATION

The LTC6431-20 is a highly linear, fixed-gain amplifier that is configured to operate single ended. Its core signal path consists of a single amplifier stage, minimizing stability issues. The input is a Darlington pair for high input impedance and high current gain. Additional circuit enhancements increase the output impedance and minimize the effects of internal Miller capacitance.

The LTC6431-20 starts with a classic RF gain block topology but adds enhancements to dramatically improve

linearity. Shunt and series feedback are added to lower the input/output impedance and match them simultaneously to the 50Ω source and load. Meanwhile, an internal bias controller optimizes the internal operating point for peak linearity over environmental changes. This circuit architecture provides low noise, excellent RF power handling capability and wide bandwidth — characteristics that are desirable for IF signal chain applications.

APPLICATIONS INFORMATION

The LTC6431-20 is a highly linear fixed gain amplifier which is designed for ease of use. Implementing an RF gain stage is often a multi-step project. Typically an RF designer must choose a bias point and design a bias network. Next we need to address impedance matching with input and output matching networks and finally add stability networks to ensure stable operation in and out of band. These tasks are handled internally within the LTC6431-20.

The LTC6431-20 has an internal self-biasing network which compensates for temperature variation and keeps the device biased for optimal linearity. Therefore input and output DC blocking capacitors are required.

Both the input and output are internally impedance matched to 50Ω from 20MHz to 1400MHz. Similarly, an RF choke is required at the output to deliver DC current to the device. The RF choke acts as a high impedance (isolation) to the DC supply which is at RF ground. Thus, the internal LTC6431-20 impedance matching is unaffected by the biasing network. The open-collector output topology can deliver much more power than an amplifier whose collector is biased through a resistor or active load.

Choosing the Right RF Choke

Not all choke inductors are created equal. It is always important to select an inductor with low R_{LOSS} , as this will drop the available voltage to the device. Also look for an inductor with high self-resonant frequency (SRF) as this will limit the upper frequency where the choke is useful. Above the SRF, the parasitic capacitance dominates and the choke impedance will drop. For these reasons, wire

wound inductors are preferred, and multilayer ceramic chip inductors should be avoided for an RF choke. Since the LTC6431-20 is capable of such wideband operation, a single choke value will probably not result in optimized performance across its full frequency band. Table 1 lists target frequency bands and suggested corresponding inductor values:

Table 1. Target Frequency Bands and Suggested Inductor Values

FREQUENCY BAND (MHz)	INDUCTOR VALUE (nH)	MODEL NUMBER	MANUFACTURER
20 to 100	1500nH	0603LS	Coilcraft www.coilcraft.com
100 to 500	560nH	0603LS	
500 to 1000	100nH	0603LS	
1000 to 2000	51nH	0603LS	

DC Blocking Capacitor

The role of a DC blocking capacitor is straightforward; block the path of DC current and allow a low series impedance path for the AC signal. Lower frequencies require a higher value of DC blocking capacitance. Generally, 1000pF to 10000pF will suffice for operation down to 20MHz. The LTC6431-20 is relatively insensitive to the choice of blocking capacitor.

RF Bypass Capacitor

RF bypass capacitors act to shunt AC signals to ground with a low impedance path. It is best to place them as close as possible to the DC power supply pins of the device. Any extra distance translates into additional series inductance which lowers the self-resonant frequency and

APPLICATIONS INFORMATION

useful bandwidth of the bypass capacitor. The suggested bypass capacitor network consists of two capacitors: a low value 1000pF capacitor to handle high frequencies in parallel with a larger 0.1 μ F capacitor to handle lower frequencies. Use ceramic capacitors of an appropriate physical size for each capacitance value (e.g., 0402 for the 1000pF and 0805 for the 0.1 μ F) to minimize the equivalent series resistance (ESR) of the capacitor.

Low Frequency Stability

Most RF gain blocks suffer from low frequency instability. To avoid any stability issues, the LTC6431-20 has an internal feedback network that lowers the gain and matches the input and output impedances at frequencies above 20MHz. This feedback network contains a series capacitor so if at some low frequency the feedback fails, the gain increases and gross impedance mismatches occur—indeed a recipe for instability. Luckily this situation is easily resolved with a parallel capacitor and resistor network on the input as seen in Test Circuit A. This network provides resistive loss at low frequencies and is bypassed by the parallel capacitor within the desired band of operation. However, if the LTC6431-20 is preceded by a low frequency termination, such as a choke, the stability network is NOT required.

Test Circuit

The test circuit shown in Figure 2 is designed to allow evaluation of the LTC6431-20 with standard single-ended 50 Ω test equipment. The circuit requires a minimum of external components. Since the LTC6431-20 is a wideband part, the evaluation test circuit is optimized for wideband operation. Obviously, for narrowband applications the circuit can be further optimized. As mentioned earlier,

input and output DC blocking capacitors are required as this device is internally biased for optimal operation. A frequency appropriate choke and decoupling capacitors are required to provide DC bias to the RF OUT node. A 5V supply should also be applied to both of the V_{CC} pins on the device. A suggested parallel 60pF, 350 Ω network has been added to the input to ensure low frequency stability. The 60pF capacitance can be increased to improve low frequency (<150MHz) performance. However, the designer needs to be sure that the impedance presented at low frequency will not create instability

Please note that a number of DNC pins are connected on the demo board. These connections are not necessary for normal circuit operation.

Exposed Pad and Ground Plane Considerations

As with any RF device, minimizing ground inductance is critical. Care should be taken with board layout using these exposed pad packages. The maximum allowable number of minimum diameter via holes should be placed underneath the exposed pad and connected to as many ground plane layers as possible. This will provide good RF ground and low thermal impedance. Maximizing the copper ground plane will also improve heat spreading and lower inductance. It is a good idea to cover the via holes with a solder mask on the back side of the PCB to prevent solder from wicking away from the critical PCB to exposed pad interface.

The LTC6431-20 is a wide bandwidth part but it is not intended for operation down to DC. The lower frequency cutoff (20MHz) is limited by on-chip matching elements.

LTC6431-20

DEMO BOARD

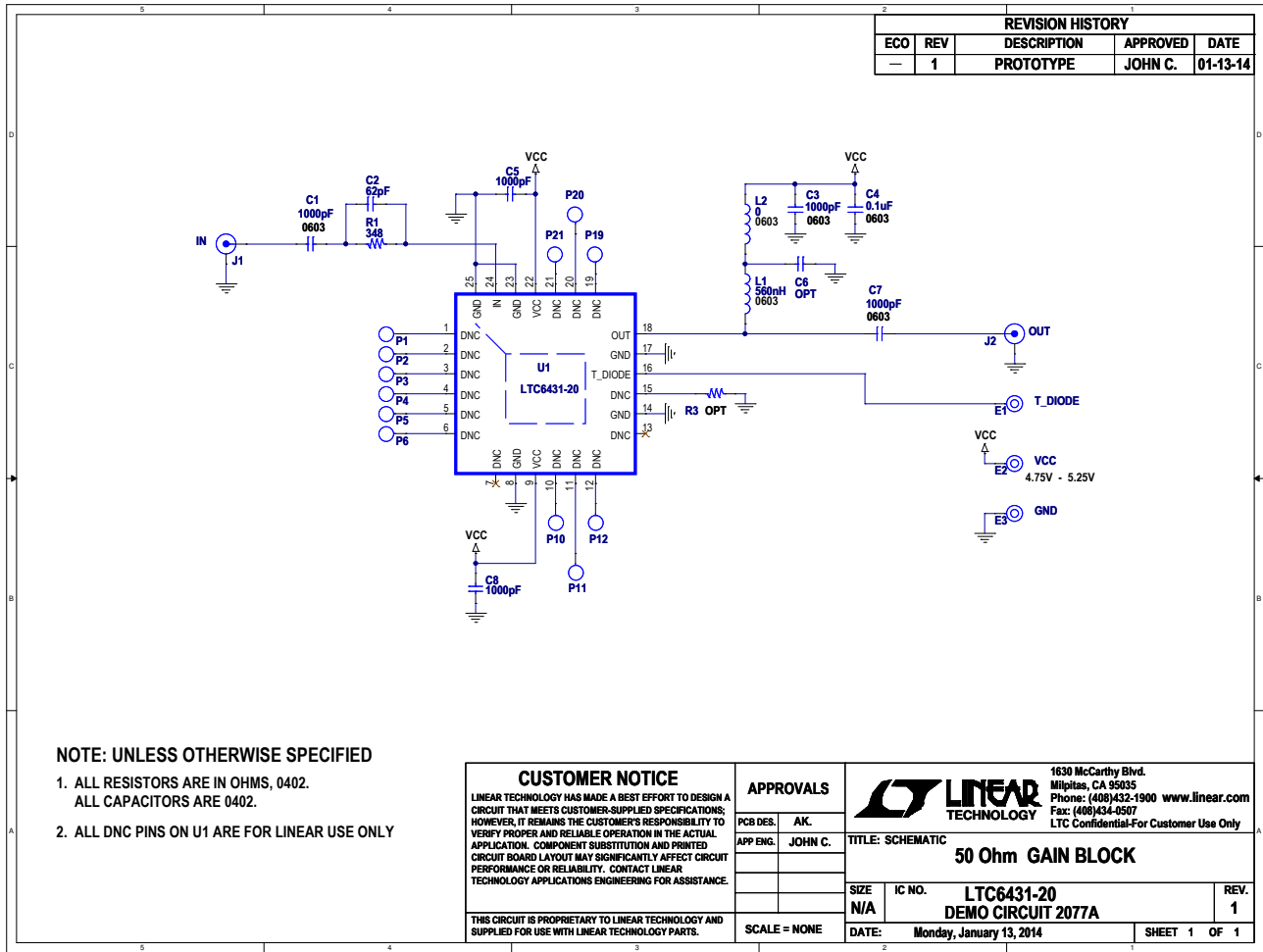


Figure 2. DC2077A Demo Board Schematic

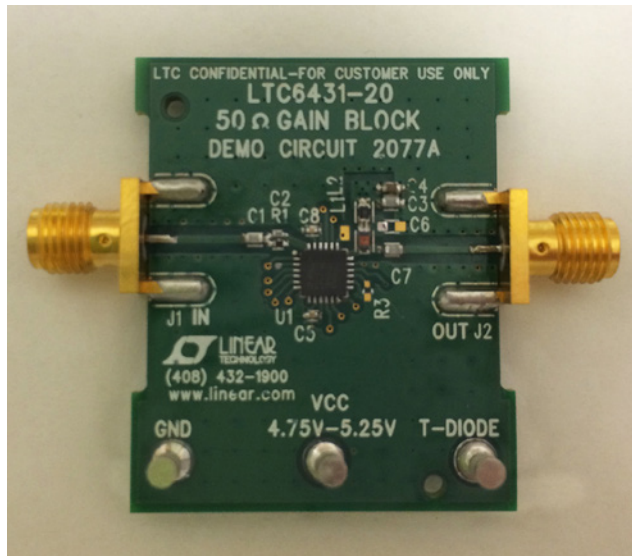


Figure 3. Demo Board

S PARAMETERS 5V, 95mA, Z = 50Ω, T_A = 25°C de-embedded to package pins

FREQUENCY (MHZ)	S11 (MAG)	S11 (PH)	S21 (MAG)	S21 (PH)	S12 (MAG)	S12 (PH)	S22 (MAG)	S22 (PH)	GTU (MAX)	STABILITY (K)
15	-12.34	-134.00	21.65	166.01	-23.63	9.07	-14.61	-124.25	22.07	0.92
60	-14.04	-170.60	21.09	171.15	-23.46	-1.42	-18.21	-175.38	21.33	0.98
105	-14.03	-179.35	21.03	168.79	-23.49	-5.14	-18.66	166.03	21.26	0.98
150	-14.08	175.80	21.01	165.71	-23.53	-8.75	-18.62	154.22	21.24	0.98
195	-14.07	172.39	20.98	162.19	-23.53	-11.98	-18.41	143.47	21.22	0.98
240	-14.15	167.78	20.98	158.68	-23.51	-14.70	-18.30	133.71	21.22	0.98
285	-14.28	163.28	20.94	155.06	-23.57	-17.52	-18.41	123.42	21.17	0.99
330	-14.39	160.26	20.90	151.22	-23.56	-20.65	-18.26	114.75	21.13	0.99
375	-14.29	156.48	20.86	147.90	-23.60	-23.49	-18.15	108.36	21.09	0.99
420	-14.21	153.43	20.83	144.33	-23.66	-26.30	-17.84	100.90	21.07	0.99
465	-14.16	149.55	20.84	140.79	-23.66	-28.96	-17.57	92.84	21.09	0.99
510	-14.23	146.15	20.81	137.22	-23.73	-31.97	-17.39	84.51	21.06	0.99
555	-14.33	141.99	20.83	133.57	-23.74	-34.94	-17.34	77.29	21.07	0.99
600	-14.44	138.03	20.82	129.91	-23.76	-37.66	-17.19	68.45	21.06	0.99
645	-14.54	132.96	20.83	126.20	-23.82	-40.56	-17.18	61.23	21.06	1.00
690	-14.61	129.14	20.82	122.55	-23.82	-43.37	-16.95	51.45	21.06	1.00
735	-14.72	125.47	20.81	118.75	-23.88	-46.23	-16.82	43.84	21.05	1.00
780	-14.82	121.92	20.83	115.24	-23.90	-49.23	-16.71	35.20	21.07	1.00
825	-15.09	117.58	20.82	111.33	-23.92	-51.95	-16.62	26.73	21.05	1.00
870	-15.49	113.60	20.86	107.36	-23.98	-55.23	-16.57	16.50	21.08	1.00
915	-15.70	109.88	20.85	103.72	-23.99	-58.08	-16.46	6.76	21.07	1.01
960	-16.07	106.95	20.87	99.43	-24.11	-61.03	-16.09	-3.10	21.08	1.01
1005	-16.34	104.03	20.83	95.71	-24.09	-64.35	-15.67	-12.60	21.05	1.01
1050	-16.85	102.41	20.87	91.50	-24.18	-67.08	-15.20	-21.77	21.10	1.01
1095	-17.27	100.19	20.86	87.64	-24.20	-70.22	-14.69	-31.60	21.09	1.01
1140	-17.95	98.62	20.82	82.93	-24.28	-73.37	-14.08	-40.57	21.06	1.01
1185	-18.45	97.87	20.83	79.39	-24.34	-76.81	-13.51	-48.89	21.09	1.01
1230	-19.02	98.94	20.77	74.51	-24.42	-79.94	-12.81	-57.15	21.06	1.02
1275	-19.50	101.29	20.79	70.33	-24.49	-83.51	-12.18	-65.26	21.11	1.01
1320	-19.85	104.33	20.60	65.52	-24.57	-86.55	-11.49	-72.53	20.96	1.02
1365	-20.08	106.87	20.62	61.84	-24.67	-90.04	-11.02	-79.96	21.02	1.01
1410	-19.95	109.72	20.45	57.31	-24.78	-93.19	-10.42	-87.02	20.91	1.01
1455	-19.77	113.75	20.46	52.82	-24.90	-96.97	-9.99	-93.77	20.97	1.01
1500	-19.51	117.49	20.24	48.67	-25.03	-100.45	-9.41	-100.97	20.82	1.01
1545	-18.89	119.17	20.18	44.22	-25.18	-103.92	-8.92	-108.10	20.83	1.01
1590	-18.24	119.82	19.98	40.21	-25.35	-107.23	-8.50	-114.08	20.71	1.01
1635	-17.42	119.84	19.95	35.90	-25.53	-111.01	-8.07	-120.18	20.76	1.00
1680	-16.67	117.91	19.72	31.69	-25.69	-113.96	-7.78	-126.41	20.60	1.00
1725	-15.83	117.38	19.66	27.35	-25.93	-118.14	-7.51	-132.99	20.63	1.00
1770	-15.05	116.13	19.36	23.32	-26.10	-121.42	-7.13	-139.50	20.44	1.00
1815	-14.19	114.01	19.28	18.99	-26.43	-124.76	-6.90	-145.49	20.45	1.00
1860	-13.50	111.51	18.90	15.44	-26.53	-128.07	-6.72	-151.16	20.14	1.02
1905	-12.85	109.19	19.01	11.94	-26.93	-131.53	-6.58	-157.57	20.31	1.02
1950	-12.24	106.89	18.52	6.50	-27.03	-135.18	-6.51	-164.06	19.89	1.04
1995	-11.67	104.26	18.70	3.97	-27.55	-137.80	-6.39	-170.92	20.14	1.05

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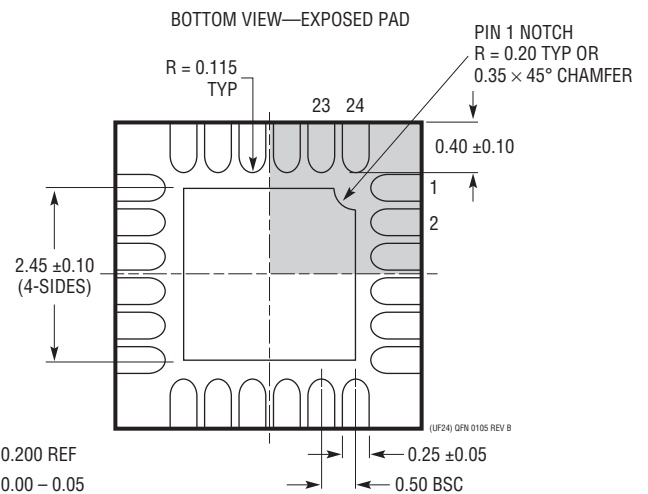
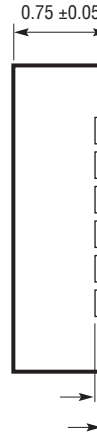
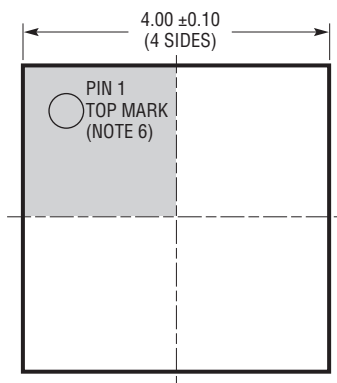
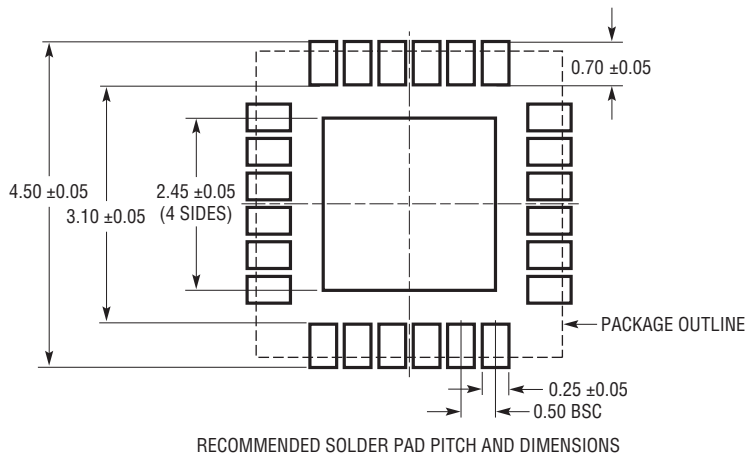
S PARAMETERS 5V, 95mA, Z = 50Ω, T_A = 25°C de-embedded to package pins

FREQUENCY (MHZ)	S11 (MAG)	S11 (PH)	S21 (MAG)	S21 (PH)	S12 (MAG)	S12 (PH)	S22 (MAG)	S22 (PH)	GTU (MAX)	STABILITY (K)
2040	-11.14	100.90	17.88	-0.72	-27.55	-142.12	-6.26	-177.67	19.40	1.10
2085	-10.64	97.70	18.36	-5.52	-28.08	-143.56	-6.12	176.54	19.97	1.08
2130	-10.00	94.35	17.25	-6.06	-28.25	-150.27	-6.05	170.42	18.94	1.18
2175	-9.61	91.25	17.78	-14.20	-28.58	-149.92	-6.02	163.95	19.53	1.14
2220	-9.17	88.10	17.05	-12.16	-29.10	-156.51	-5.98	156.51	18.87	1.27
2265	-8.83	84.64	16.93	-20.90	-29.21	-157.46	-5.82	149.75	18.85	1.26
2310	-8.46	81.25	16.78	-18.18	-29.86	-162.26	-5.78	143.79	18.78	1.34
2355	-8.16	77.66	16.61	-27.54	-29.98	-162.93	-5.73	137.46	18.68	1.35
2400	-7.83	74.62	16.50	-25.19	-30.69	-167.63	-5.69	131.27	18.64	1.45
2445	-7.53	71.16	16.06	-34.94	-30.51	-168.53	-5.62	125.41	18.30	1.45
2490	-7.27	68.07	16.20	-31.94	-31.57	-172.15	-5.67	118.93	18.47	1.60
2535	-6.92	64.84	15.35	-40.99	-31.02	-175.82	-5.56	113.08	17.75	1.59
2580	-6.70	61.73	16.03	-39.80	-32.38	-175.70	-5.57	107.60	18.49	1.70
2625	-6.41	58.18	14.68	-45.37	-32.09	176.58	-5.50	101.45	17.24	1.87
2670	-6.27	55.57	15.67	-47.21	-32.97	179.37	-5.63	95.57	18.23	1.85
2715	-6.03	52.10	14.17	-49.38	-32.98	169.92	-5.56	90.99	16.82	2.16
2760	-5.89	49.48	15.57	-53.97	-33.09	175.85	-5.27	85.87	18.39	1.75
2805	-5.67	45.63	13.93	-53.77	-34.22	163.49	-5.21	80.99	16.86	2.40
2850	-5.50	42.67	15.09	-63.32	-33.44	166.56	-5.17	75.72	18.10	1.84
2895	-5.46	39.67	13.89	-58.19	-35.33	159.61	-5.18	70.71	16.91	2.69
2940	-5.30	36.08	14.37	-72.34	-34.24	156.24	-5.09	65.83	17.50	2.14
2985	-5.19	33.25	13.99	-65.16	-35.94	156.17	-5.09	61.31	17.17	2.74
3030	-5.01	30.47	13.73	-77.37	-35.59	148.57	-4.97	56.55	17.04	2.62
3075	-4.92	27.89	13.65	-74.73	-36.56	148.06	-4.90	53.19	17.03	2.92
3120	-4.91	24.65	13.20	-83.66	-36.86	137.09	-4.91	49.53	16.59	3.20
3165	-4.82	22.03	13.19	-82.28	-37.44	140.21	-4.93	45.90	16.61	3.42
3210	-4.75	18.92	12.70	-90.39	-38.12	129.33	-4.92	41.35	16.17	3.90
3255	-4.68	16.03	12.57	-89.72	-38.72	129.83	-4.86	37.27	16.09	4.20
3300	-4.59	13.26	12.24	-97.59	-39.34	121.95	-4.83	33.29	15.82	4.64
3345	-4.55	10.73	11.84	-98.06	-39.73	119.68	-4.77	29.79	15.48	5.05
3390	-4.56	8.20	11.62	-103.89	-40.66	109.67	-4.74	27.13	15.26	5.79
3435	-4.51	5.01	10.89	-101.79	-41.66	111.26	-4.81	24.06	14.53	7.15
3480	-4.45	2.35	11.06	-111.51	-43.12	101.22	-4.88	20.14	14.70	8.34
3525	-4.43	-0.44	10.16	-107.21	-42.93	99.02	-4.93	15.63	13.79	9.10
3570	-4.41	-2.83	9.99	-117.04	-45.97	89.65	-4.84	11.54	13.68	13.14
3615	-4.40	-5.71	9.68	-110.63	-44.49	84.10	-4.90	8.34	13.33	11.53
3660	-4.38	-8.39	8.93	-121.14	-47.04	75.52	-5.05	3.84	12.53	17.24
3705	-4.34	-11.28	9.26	-114.41	-46.78	68.74	-5.08	-0.41	12.86	16.05
3750	-4.29	-13.61	8.25	-123.30	-48.84	61.49	-5.19	-4.64	11.84	23.09
3795	-4.26	-16.54	8.99	-119.02	-48.49	43.03	-5.23	-10.04	12.58	20.33
3840	-4.23	-18.89	7.52	-126.22	-50.09	36.00	-5.24	-14.83	11.12	29.00
3885	-4.21	-21.65	8.40	-125.79	-51.80	18.74	-5.26	-19.77	12.01	31.89
3930	-4.20	-23.89	7.12	-125.77	-50.77	12.06	-5.34	-24.50	10.70	33.05
3975	-4.15	-26.81	7.91	-131.37	-50.96	2.88	-5.43	-30.21	11.49	30.86
4020	-4.11	-29.36	6.95	-128.17	-49.54	-0.70	-5.41	-36.65	10.56	29.01

PACKAGE DESCRIPTION

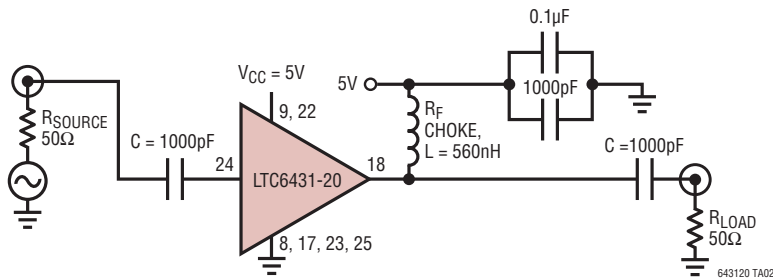
Please refer to <http://www.linear.com/designtools/packaging/> for the most recent package drawings.

UF Package
24-Lead Plastic QFN (4mm × 4mm)
 (Reference LTC DWG # 05-08-1697 Rev B)



- NOTE:
1. DRAWING PROPOSED TO BE MADE A JEDEC PACKAGE OUTLINE MO-220 VARIATION (WGGD-X)—TO BE APPROVED
 2. DRAWING NOT TO SCALE
 3. ALL DIMENSIONS ARE IN MILLIMETERS
 4. DIMENSIONS OF EXPOSED PAD ON BOTTOM OF PACKAGE DO NOT INCLUDE MOLD FLASH. MOLD FLASH, IF PRESENT, SHALL NOT EXCEED 0.15mm ON ANY SIDE, IF PRESENT
 5. EXPOSED PAD SHALL BE SOLDER PLATED
 6. SHADED AREA IS ONLY A REFERENCE FOR PIN 1 LOCATION ON THE TOP AND BOTTOM OF PACKAGE

TYPICAL APPLICATION



RELATED PARTS

PART NUMBER	DESCRIPTION	COMMENTS
Fixed Gain IF Amplifiers/ADC Drivers		
LTC6431-15	15dB Gain 50Ω Gain Block IF Amplifier — Single Ended	OIP3 = 47dBm at 240MHz, 20MHz to 1700MHz Bandwidth, 3.3dB NF
LTC6430-15	15dB Gain Block IF Amplifier — Differential	OIP3 = 50dBm at 240MHz, 20MHz to 1700MHz Bandwidth, 3.3dB NF
LTC6417	1.6GHz Low Noise High Linearity Differential Buffer/ADC Driver	OIP3 = 41dBm at 300MHz, Can Drive 50Ω Differential Output, High Speed Voltage Clamping Protects Subsequent Circuitry
LTC6416	2GHz, 16-Bit Differential ADC Buffer	-72dBc IM2 at 300MHz 2V _{p-p} Composite, I _S = 42mA, e _N = 2.8nV/√Hz, A _V = 0dB, 300MHz
LTC6410-6	1.4GHz Differential IF Amplifier with Configurable Input Impedance	OIP3 = 36dBm at 70MHz, Flexible Interface-to-Mixer IF Port
LTC6400-8/LTC6400-14/ LTC6400-20/LTC6400-26	1.8GHz Low Noise, Low Distortion Differential ADC Drivers	-71dBc IM3 at 240MHz 2V _{p-p} Composite, I _S = 90mA, A _V = 8dB, 14dB, 20dB, 26dB
LTC2420-20	Dual 1.8GHz Low Noise, Low Distortion Differential ADC Drivers	Dual Version of the LTC6400-20, A _V = 20dB
Variable Gain IF Amplifiers/ADC Drivers		
LTC6412	800MHz, 31dB Range Analog-Controlled VGA	OIP3 = 35dBm at 240MHz, Continuously-Adjustable Gain Control
Baseband Differential Amplifiers		
LTC6409	1.1nV/√Hz Single Supply Differential Amplifier/ADC Driver	88dB SFDR at 100MHz, AC- or DC-Coupled Inputs
LT6411	Low Power Differential ADC Driver/Dual Selectable Gain Amplifier	-83dBc IM3 at 70MHz 2V _{p-p} Composite, A _V = 1, -1 or 2, 16mA, Excellent for Single-Ended to Differential Conversion
LTC6406	3GHz Rail-to-Rail Input Differential Amplifier/ADC Driver	-65dBc IM3 at 50MHz 2V _{p-p} Composite, Rail-to-Rail Inputs, e _N = 1.6nV/√Hz, 18mA
LTC6404-1/LTC6404-2	Low Noise Rail-to-Rail Output Differential Amplifier/ADC Driver	16-Bit SNR, SFDR at 10MHz, Rail-to-Rail Outputs, e _N = 1.5nV/√Hz, LTC6404-1 Is Unity-Gain Stable, LTC6404-2 Is Gain-of-2 Stable
LTC6403-1	Low Noise Rail-to-Rail Output Differential Amplifier/ADC Driver	16-Bit SNR, SFDR at 3MHz, Rail-to-Rail Outputs, e _N = 2.8nV/√Hz
High Speed ADCs		
LTC2208/LTC2209	16-Bit, 130MSPS/160MSPS ADCs	74.0dBFS Noise Floor, SFDR > 89dB at 140MHz, 2.25V _{p-p} Input
LTC2259-16	16-Bit, 80MSPS 1.8V ADC	72.0dBFS Noise Floor, SFDR > 82dB at 140MHz, 2.00V _{p-p} Input
LTC2160-16/LTC2161-16/ LTC2162-16	16-Bit, 25MSPS/40MSPS/60MSPS ADC Low Power	77dBFS Noise Floor, SFDR > 84dB at 140MHz, 2.00V _{p-p} Input
LTC2155-14/LTC2156-14/ LTC2157-14/LTC2158-14	14-Bit, 170MSPS/210MSPS/250MSPS/310MSPS ADC 2-Channel	69dBFS Noise Floor, SFDR > 80dB at 140MHz, 1.50V _{p-p} Input, >1GHz Input BW
LTC2216	16-Bit, 80MSPS ADC	79dBFS Noise Floor, SFDR > 91dB at 140MHz, 75V _{p-p} Input



Компания «ЭлектроПласт» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

Наши преимущества:

- Оперативные поставки широкого спектра электронных компонентов отечественного и импортного производства напрямую от производителей и с крупнейших мировых складов;
- Поставка более 17-ти миллионов наименований электронных компонентов;
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
- Поставка специализированных компонентов (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Aeroflex, Peregrine, Syfer, Eurofarad, Texas Instrument, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Помимо этого, одним из направлений компании «ЭлектроПласт» является направление «Источники питания». Мы предлагаем Вам помощь Конструкторского отдела:

- Подбор оптимального решения, техническое обоснование при выборе компонента;
- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



Как с нами связаться

Телефон: 8 (812) 309 58 32 (многоканальный)

Факс: 8 (812) 320-02-42

Электронная почта: org@eplast1.ru

Адрес: 198099, г. Санкт-Петербург, ул. Калинина, дом 2, корпус 4, литера А.